

N-Channel and P-Channel Enhancement-Mode Dual MOSFET

Features

- Low Threshold
- Low On-Resistance
- Low Input Capacitance
- Fast Switching Speeds
- Free from Secondary Breakdown
- Low Input and Output Leakage
- Independent, Electrically Isolated N-Channel and P-Channel

Applications

- Medical Ultrasound Transmitters
- High-Voltage Pulsers
- Amplifiers
- Buffers
- Piezoelectric Transducer Drivers
- General Purpose Line Drivers
- Logic-Level Interface

General Description

The TC2320 consists of a high-voltage, low-threshold N-channel and P-channel MOSFET in an 8-Lead SOIC package. This Enhancement-mode (normally-off) transistor uses an advanced vertical DMOS structure and a well-proven silicon gate manufacturing process. This combination produces a device with the power handling capabilities of bipolar transistors and high input impedance and positive temperature coefficient inherent in MOS devices. Characteristic of all MOS structures, this device is free from thermal runaway and thermally induced secondary breakdown.

Microchip's vertical DMOS FETs are ideally suited for a wide range of switching and amplifying applications where very low threshold voltage, high breakdown voltage, high input impedance, low input capacitance and fast switching speeds are desired.

Package Type



See [Table 2-1](#) for pin information.

1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Drain-to-Source Voltage	BV_{DSS}
Drain-to-Gate Voltage	BV_{DGS}
Gate-to-Source Voltage	$\pm 20V$
Operating Ambient Temperature, T_A	$-55^{\circ}C$ to $+150^{\circ}C$
Storage Temperature, T_S	$-55^{\circ}C$ to $+150^{\circ}C$

† **Notice:** Stresses above those listed under “Absolute Maximum Ratings” may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

N-CHANNEL DC AND AC ELECTRICAL CHARACTERISTICS

Electrical Specifications: Unless otherwise noted, $T_A = T_J = +25^{\circ}C$.

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
DC PARAMETER (Note 1)						
Drain-to-Source Breakdown Voltage	BV_{DSS}	200	—	—	V	$V_{GS} = 0V, I_D = 100\ \mu A$
Gate Threshold Voltage	$V_{GS(th)}$	0.6	—	2	V	$V_{GS} = V_{DS}, I_D = 1\ mA$
Change in $V_{GS(th)}$ with Temperature	$\Delta V_{GS(th)}$	—	—	−4.5	mV/°C	$V_{GS} = V_{DS}, I_D = 1\ mA$ (Note 2)
Gate Body Leakage Current	I_{GSS}	—	—	100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$
Zero-Gate Voltage Drain Current	I_{DSS}	—	—	1	μA	$V_{GS} = 0V, V_{DS} = 100V$
		—	—	10	μA	$V_{GS} = 0V, V_{DS} = \text{Maximum rating}$
		—	—	1	mA	$V_{GS} = 0V, T_A = 125^{\circ}C,$ $V_{DS} = 0.8\ \text{Maximum rating}$ (Note 2)
On-State Drain Current	$I_{D(ON)}$	0.6	—	—	A	$V_{GS} = 4.5V, V_{DS} = 25V$
		1.2	—	—	A	$V_{GS} = 10V, V_{DS} = 25V$
Static Drain-to-Source On-State Resistance	$R_{DS(ON)}$	—	—	8	Ω	$V_{GS} = 4.5V, I_D = 150\ mA$
		—	—	7	Ω	$V_{GS} = 10V, I_D = 1A$
Change in $R_{DS(ON)}$ with Temperature	$\Delta R_{DS(ON)}$	—	—	1	%/°C	$V_{GS} = 4.5V, I_D = 150\ mA$ (Note 2)
AC PARAMETER (Note 2)						
Forward Transconductance	G_{FS}	150	—	—	mmho	$V_{DS} = 25V, I_D = 200\ mA$
Input Capacitance	C_{ISS}	—	—	110	pF	$V_{GS} = 0V,$ $V_{DS} = 25V,$ $f = 1\ MHz$
Common Source Output Capacitance	C_{OSS}	—	—	60	pF	
Reverse Transfer Capacitance	C_{RSS}	—	—	23	pF	
Turn-On Delay Time	$t_{d(ON)}$	—	—	20	ns	$V_{DD} = 25V,$ $I_D = 150\ mA,$ $R_{GEN} = 25\Omega$
Rise Time	t_r	—	—	15	ns	
Turn-Off Delay Time	$t_{d(OFF)}$	—	—	25	ns	
Fall Time	t_f	—	—	25	ns	
DIODE PARAMETER						
Diode Forward Voltage Drop	V_{SD}	—	—	1.8	V	$V_{GS} = 0V, I_{SD} = 200\ mA$ (Note 1)
Reverse Recovery Time	t_{rr}	—	300	—	ns	$V_{GS} = 0V, I_{SD} = 200\ mA$ (Note 2)

Note 1: Unless otherwise stated, all DC parameters are 100% tested at $+25^{\circ}C$.

Pulse test: 300 μs pulse, 2% duty cycle.

2: Specification is obtained by characterization and is not 100% tested.

P-CHANNEL DC AND AC ELECTRICAL CHARACTERISTICS

Electrical Specifications: Unless otherwise noted, $T_A = T_J = +25^{\circ}\text{C}$.						
Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
DC PARAMETER (Note 1)						
Drain-to-Source Breakdown Voltage	BV_{DSS}	-200	—	—	V	$V_{GS} = 0\text{V}$, $I_D = -2\text{ mA}$
Gate Threshold Voltage	$V_{GS(th)}$	-1	—	-2.4	V	$V_{GS} = V_{DS}$, $I_D = -1\text{ mA}$
Change in $V_{GS(th)}$ with Temperature	$\Delta V_{GS(th)}$	—	—	4.5	mV/ $^{\circ}\text{C}$	$V_{GS} = V_{DS}$, $I_D = -1\text{ mA}$ (Note 2)
Gate Body Leakage	I_{GSS}	—	—	-100	nA	$V_{GS} = \pm 20\text{V}$, $V_{DS} = 0\text{V}$
Zero-Gate Voltage Drain Current	I_{DSS}	—	—	-10	μA	$V_{GS} = 0\text{V}$, $V_{DS} = \text{Maximum rating}$
		—	—	-1	mA	$V_{GS} = 0\text{V}$, $T_A = 125^{\circ}\text{C}$, $V_{DS} = 0.8 \text{ Maximum rating}$ (Note 2)
On-State Drain Current	$I_{D(ON)}$	-0.25	-0.7	—	A	$V_{GS} = -4.5\text{V}$, $V_{DS} = -25\text{V}$
		-0.75	-2.1	—	A	$V_{GS} = -10\text{V}$, $V_{DS} = -25\text{V}$
Static Drain-to-Source On-State Resistance	$R_{DS(ON)}$	—	10	15	Ω	$V_{GS} = -4.5\text{V}$, $I_D = -100\text{ mA}$
		—	8	12	Ω	$V_{GS} = -10\text{V}$, $I_D = -200\text{ mA}$
Change in $R_{DS(ON)}$ with Temperature	$\Delta R_{DS(ON)}$	—	—	1.7	%/ $^{\circ}\text{C}$	$V_{GS} = -10\text{V}$, $I_D = -200\text{ mA}$ (Note 2)
AC PARAMETER (Note 2)						
Forward Transconductance	G_{FS}	100	250	—	mmho	$V_{DS} = -25\text{V}$, $I_D = -200\text{ mA}$
Input Capacitance	C_{ISS}	—	75	125	pF	$V_{GS} = 0\text{V}$, $V_{DS} = -25\text{V}$, $f = 1\text{ MHz}$
Common-Source Output Capacitance	C_{OSS}	—	20	85	pF	
Reverse Transfer Capacitance	C_{RSS}	—	10	35	pF	
Turn-On Delay Time	$t_{d(ON)}$	—	—	10	ns	$V_{DD} = -25\text{V}$, $I_D = -0.75\text{A}$, $R_{GEN} = 25\Omega$
Rise Time	t_r	—	—	15	ns	
Turn-Off Delay Time	$t_{d(OFF)}$	—	—	20	ns	
Fall Time	t_f	—	—	15	ns	
DIODE PARAMETER						
Diode Forward Voltage Drop	V_{SD}	—	—	-1.8	V	$V_{GS} = 0\text{V}$, $I_{SD} = -0.5\text{A}$ (Note 1)
Reverse Recovery Time	t_{rr}	—	300	—	ns	$V_{GS} = 0\text{V}$, $I_{SD} = -0.5\text{A}$ (Note 2)

Note 1: Unless otherwise stated, all DC parameters are 100% tested at $+25^{\circ}\text{C}$. Pulse test: 300 μs pulse, 2% duty cycle.

2: Specification is obtained by characterization and is not 100% tested.

TEMPERATURE SPECIFICATIONS

Parameter	Sym.	Min.	Typ.	Max.	Unit	Conditions
TEMPERATURE RANGE						
Operating Ambient Temperature	T_A	-55	—	+150	$^{\circ}\text{C}$	
Storage Temperature	T_S	-55	—	+150	$^{\circ}\text{C}$	
PACKAGE THERMAL RESISTANCE						
8-lead SOIC	θ_{JA}	—	101	—	$^{\circ}\text{C/W}$	Note 1

Note 1: 1 oz., four-layer, 3" x 4" PCB

2.0 PIN DESCRIPTION

Table 2-1 shows the description of pins in TC2320.
Refer to [Package Type](#) for the location of pins.

TABLE 2-1: PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	SN	Source N-channel
2	GN	Gate N-channel
3	SP	Source P-channel
4	GP	Gate P-channel
5	DP	Drain P-channel
6	DP	Drain P-channel
7	DN	Drain N-channel
8	DN	Drain N-channel

3.0 FUNCTIONAL DESCRIPTION

Figure 3-1 and Figure 3-2 illustrate the switching waveforms and test circuits for TC2320.

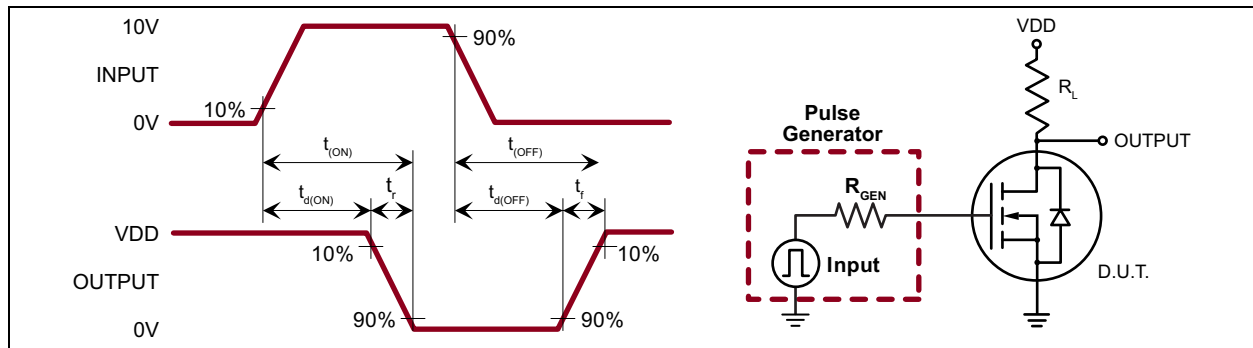


FIGURE 3-1: N-Channel Switching Waveforms and Test Circuit.

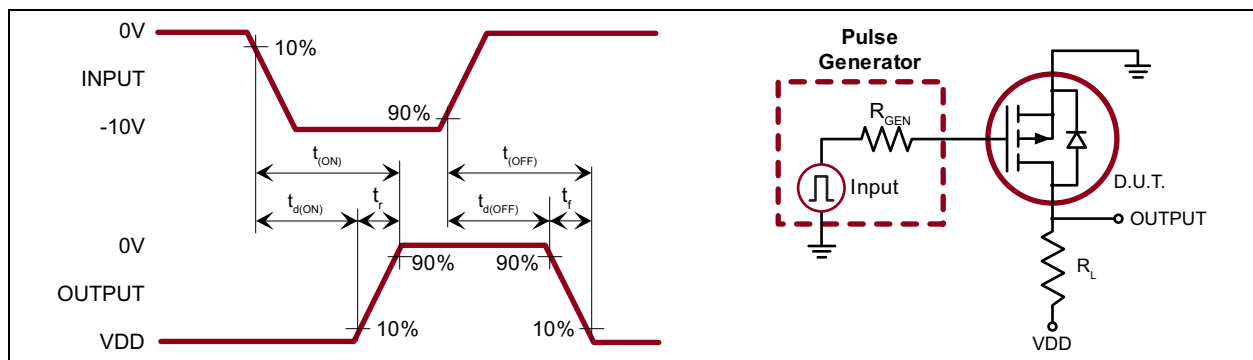


FIGURE 3-2: P-Channel Switching Waveforms and Test Circuit.

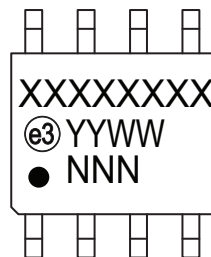
TABLE 3-1: PRODUCT SUMMARY

BV_{DSS}/BV_{DGS} (V)		$R_{DS(ON)}$ (Maximum) (Ω)	
N-Channel	P-Channel	N-Channel	P-Channel
200	-200	7	12

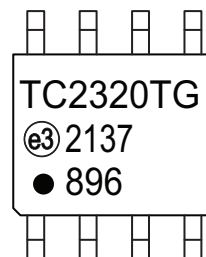
4.0 PACKAGING INFORMATION

4.1 Package Marking Information

8-lead SOIC



Example

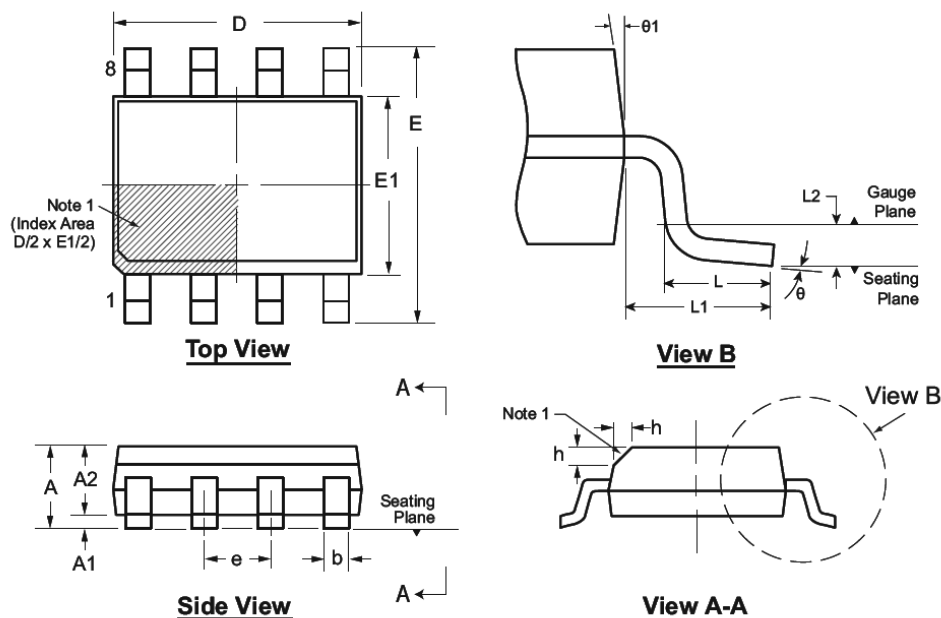


Legend:	XX...X	Product Code or Customer-specific information
	Y	Year code (last digit of calendar year)
	YY	Year code (last 2 digits of calendar year)
	WW	Week code (week of January 1 is week '01')
	NNN	Alphanumeric traceability code
	(e3)	Pb-free JEDEC® designator for Matte Tin (Sn)
	*	This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line, thus limiting the number of available characters for product code or customer-specific information. Package may or not include the corporate logo.

8-Lead SOIC (Narrow Body) Package Outline (LG/TG)

4.90x3.90mm body, 1.75mm height (max), 1.27mm pitch



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Note:

1. This chamfer feature is optional. A Pin 1 identifier must be located in the index area indicated. The Pin 1 identifier can be: a molded mark/identifier; an embedded metal marker; or a printed indicator.

Symbol		A	A1	A2	b	D	E	E1	e	h	L	L1	L2	θ	θ1
Dimension (mm)	MIN	1.35*	0.10	1.25	0.31	4.80*	5.80*	3.80*	1.27 BSC	0.25	0.40	1.04 REF	0.25 BSC	0°	5°
	NOM	-	-	-	-	4.90	6.00	3.90		-	-			-	-
	MAX	1.75	0.25	1.65*	0.51	5.00*	6.20*	4.00*		0.50	1.27			-	8°

JEDEC Registration MS-012, Variation AA, Issue E, Sept. 2005.

* This dimension is not specified in the JEDEC drawing.

Drawings are not to scale.

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (June 2017)

- Converted Supertex Doc# DSFP-TC2320 to Microchip DS20005708A
- Changed packaging format
- Changed the packaging quantity of the 8-lead SOIC TG package from 2000/Reel to 3300/Reel
- Made minor text changes throughout the document

Revision B (March 2021)

- Corrected the On-State Drain Current V_{DS} condition and changed the value from $-5V$ to $-25V$
- Made minor text changes throughout the document

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

<u>PART NO.</u>	<u>XX</u>	-	<u>X</u>	-	<u>X</u>
Device	Package Options		Environmental		Media Type
Device:	TC2320	=	N-Channel and P-Channel Enhancement-Mode Dual MOSFET		
Package:	TG	=	8-lead SOIC		
Environmental:	G	=	Lead (Pb)-free/RoHS-compliant Package		
Media Type:	(blank)	=	3300/Reel for a TG Package		

Example:

a) TC2320TG-G: N-Channel and P-Channel Enhancement-ModeDualMOSFET, 8-lead SOIC, 3300/Reel

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